

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Hiromitsu Nishino	02/19/2018
Etsuro Hirota	03/13/2018
Koji Kumakura	03/08/2018
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<b>Name:</b>	SEKISUI CHEMICAL CO., LTD.
<b>Street Address:</b>	4-4, Nishitemma 2-chome, Kita-ku
<b>City:</b>	Osaka-city, Osaka
<b>State/Country:</b>	Japan
<b>Postal Code:</b>	530-8565
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15762466
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	MIY-0544
<b>NAME OF SUBMITTER:</b>	LEE CHENG
<b>SIGNATURE:</b>	/Lee Cheng/
<b>DATE SIGNED:</b>	03/22/2018
<b>Total Attachments: 4</b>	
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代理人整理番号 Docket No. \_\_\_\_\_

## U.S. ASSIGNMENT 米国譲渡証

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by  
本証末尾に署名した発明者（以下「譲渡人」という）は

[Insert  
ASSIGNEE's  
Name(s)  
Address(es)]  
[譲受人の氏名と住所]

SEKISUI CHEMICAL CO., LTD.  
4-4, Nishitemma 2-chome, Kita-ku, Osaka-city, Osaka 530-8565 JAPAN

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE all of the right, title and interest to the invention entitled

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[Title of  
Invention]  
[発明の名称]

INTERLAYER FOR LAMINATED GLASS, AND LAMINATED GLASS

[\*If the assignment  
is being filed  
after the filing of the  
application, this  
section must be  
completed]  
[出願の提出後に譲渡証を  
提出する場合必ずご記入し  
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for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

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\*filed on \_\_\_\_\_, Serial No. \_\_\_\_\_  
出願日 \_\_\_\_\_ 米国特許出願番号 \_\_\_\_\_

(Cheng Law Group, PLLC is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

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当該発明の特許出願だけではなく特許出願に関する継続出願、分割出願、更新出願、代替出願、再発行出願及び再審査出願を全て譲渡する。

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IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).  
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[Signature(s)  
of Assignor(s)]  
[発明者の署名]

Hiromitsu NISHINO  
(SIGNATURE) (署名)

Hiromitsu NISHINO  
(TYPE NAME) (氏名)

19th Feb. 2018  
(DATE) (日付)

Etsuro HIRATA  
(SIGNATURE) (署名)

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Koji KUMAKURA  
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**PATENT**

**REEL: 045320 FRAME: 0664**

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[Signature(s)  
of Assignor(s)]  
[発明者の署名]

_____ (SIGNATURE) (署名)	Hiromitsu NISHINO _____ (TYPE NAME) (氏名)	_____ (DATE) (日付)
_____ (SIGNATURE) (署名)	Etsuro HIROTA _____ (TYPE NAME) (氏名)	_____ (DATE) (日付)
Koji KUMAKURA _____ (SIGNATURE) (署名)	Koji KUMAKURA _____ (TYPE NAME) (氏名)	March 8, 2018 _____ (DATE) (日付)
_____ (SIGNATURE) (署名)	_____ (TYPE NAME) (氏名)	_____ (DATE) (日付)
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